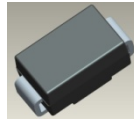


Features

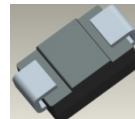
- Low Leakage Current
- Patented Super Barrier Rectifier Technology
- Soft, Fast Switching Capability
- +150°C Operating Junction Temperature
- **Lead Free Finish, RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- **SBR3A40SAQ Qualified to AEC-Q101 standards for High Reliability.**

Mechanical Data

- Case: SMA
- Case Material: Molded Plastic, "Green" Molding compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020D
- Terminals: Lead Free Plating (Matte Tin Finish.) Solderable per MIL-STD-202, Method 208
- Polarity Indicator: Cathode Band
- Marking Information: See Page 3
- Ordering Information: See Page 3
- Weight: 0.064 grams (approximate)



Top View



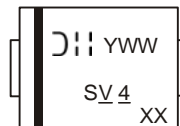
Bottom View

Ordering Information (Note 4)

Part Number	Compliance	Case	Packaging
SBR3A40SA-13	Commercial	SMA	5000/Tape & Reel
SBR3A40SAQ-13	Automotive	SMA	5000/Tape & Reel

- Notes:
1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
 4. For packaging details, go to our website at <http://www.diodes.com/products/packages.html>.
 5. Product manufactured with Data Code 0924 (week 24, 2009) and newer are built with Green Molding Compound.

Marking Information



SV 4 = Product Type Marking Code
YWW = Manufacturers' code marking
YWW = Date Code Marking
Y = Last digit of year (ex: 7 for 2007)
WW = Week code 01 to 52

- Notes: 6. Device has a cathode band (as shown above) and may also have a cathode notch.

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load
 For capacitance load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage	V _{RRM}	40	V
Working Peak Reverse Voltage	V _{RWM}		
DC Blocking Voltage	V _{RM}		
Maximum Voltage Rate of Change (Rated V _R)	dv/dt	10,000	V/μs
RMS Reverse Voltage	V _{R(RMS)}	28	V
Average Rectified Output Current	I _O	3	A
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I _{FSM}	45	A

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Maximum Thermal Resistance	R _{θJS}	5	°C/W
Thermal Resistance Junction to Soldering (Note 7)	R _{θJA}	124	
Thermal Resistance Junction to Ambient (Note 8)	R _{θJC}	14.3	
Power Dissipation (Note 8) @T _A = +25°C	P _D	1.2	W
Operating and Storage Temperature Range	T _J , T _{STG}	-65 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 10)	V _{(BR)R}	40	–	–	V	I _R = 0.4mA
Forward Voltage Drop	V _F	–	0.30	0.35	V	I _F = 0.5A, T _J = +25°C
			0.33	0.38		I _F = 1.0A, T _J = +25°C
			0.43	0.50		I _F = 3.0A, T _J = +25°C
			–	0.48		I _F = 3.0A, T _J = +125°C
Leakage Current (Note 10)	I _R	–	45	250	μA	V _R = 5V, T _J = +25°C
			80	400	μA	V _R = 40V, T _J = +25°C
			9	40	mA	V _R = 40V, T _J = +125°C

- Notes:
7. Theoretical R_{θJS} calculated from the top center of the die straight down to the PCB cathode tab solder junction.
 8. FR-4 PCB, 2 oz. Copper, minimum recommended pad layout per <http://www.diodes.com/datasheets/ap02001.pdf>.
 9. Polyimide PCB, 2 oz. Copper, minimum recommended pad layout per <http://www.diodes.com/datasheets/ap02001.pdf>.
 10. Short duration pulse test used to minimize self-heating effect.
 11. FR-4 PCB, 2 oz. Copper, single side 16 x MRP, 1" x 1" PC Board.

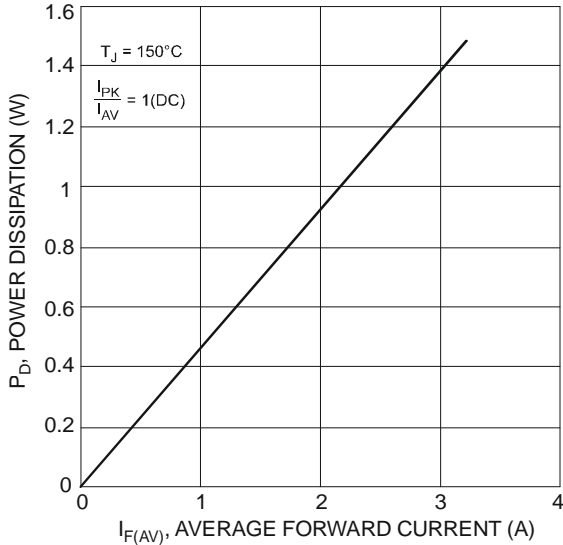


Fig. 1 Forward Power Dissipation

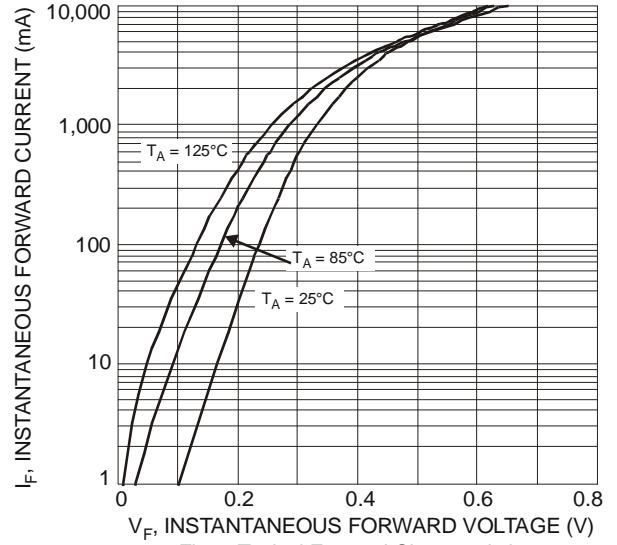


Fig. 2 Typical Forward Characteristics

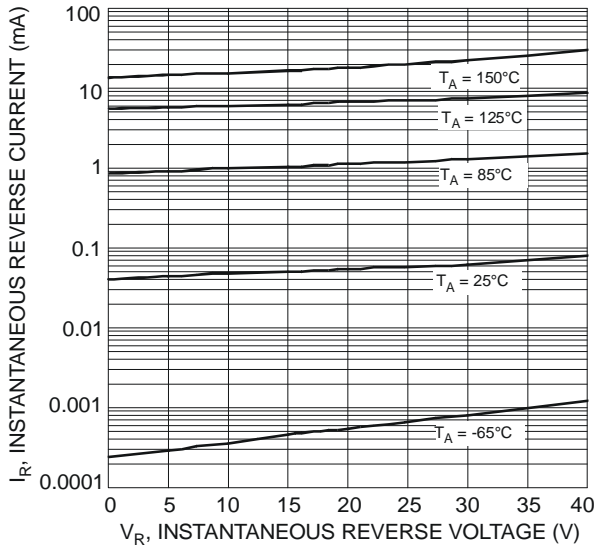


Fig. 3 Typical Reverse Characteristics

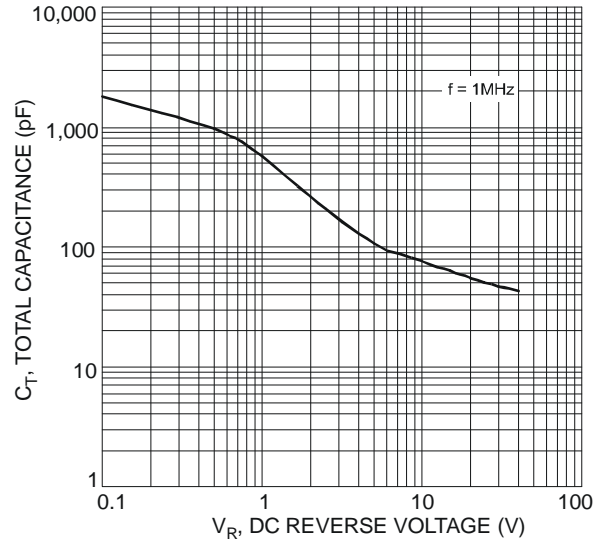


Fig. 4 Total Capacitance vs. Reverse Voltage

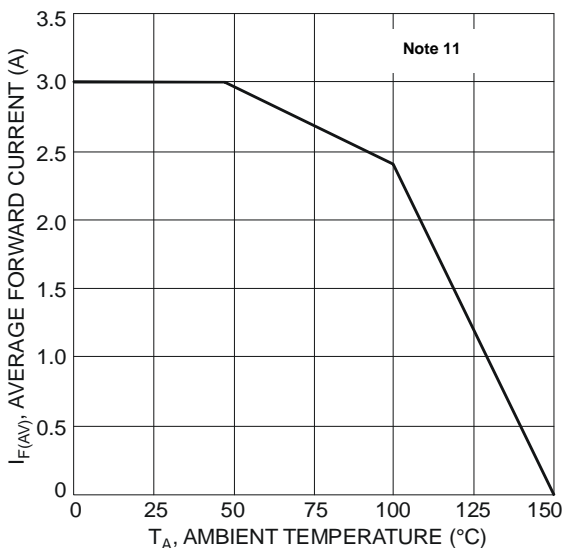


Fig. 5 Forward Current Derating Curve

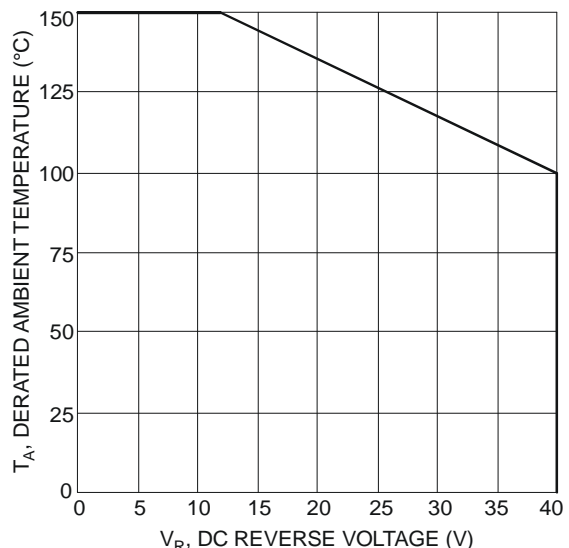
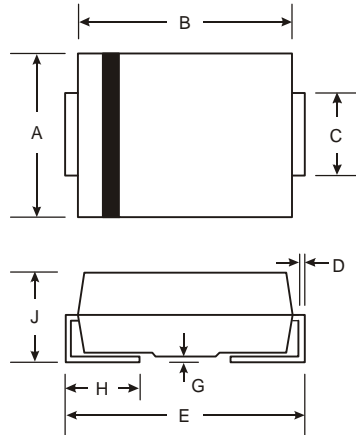


Fig. 6 Operating Temperature Derating

Package Outline Dimensions

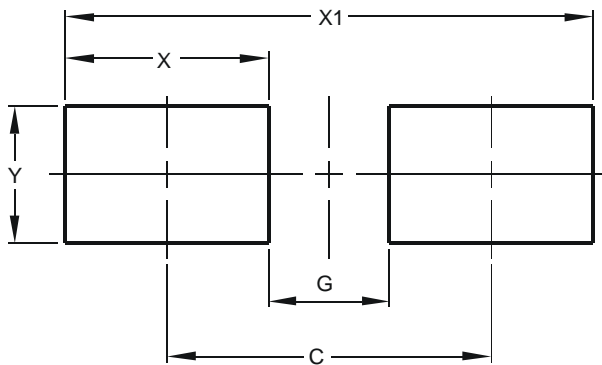
Please see AP02002 at <http://www.diodes.com/datasheets/ap02002.pdf> for latest version.



SMA		
Dim	Min	Max
A	2.29	2.92
B	4.00	4.60
C	1.27	1.63
D	0.15	0.31
E	4.80	5.59
G	0.05	0.20
H	0.76	1.52
J	2.01	2.30
All Dimensions in mm		

Suggested Pad Layout

Please see AP02001 at <http://www.diodes.com/datasheets/ap02001.pdf> for the latest version.



Dimensions	Value (in mm)
C	4.00
G	1.50
X	2.50
X1	6.50
Y	1.70

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